



PCB LAYOUT

- Note:
- Material:
 - Housing: High temperature thermoplastic with 9.f,UL94V-0
 - Contact: copper alloy t=0.15mm
 - Shell: copper alloy@SUS
 - Specification:
 - Current rating: 1 A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 30 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.after 10000 insertion/extraction cycles
 - Temperature range: -30°C~80°C

鉦創科技有限公司 TRONTEK TECHNOLOGY CO., LTD.			
TOLERANCE: XX ±0.30 XXX ±0.25 XXXX ±0.15 X° ±5°	DRAWN BY : ANDY	DATE : 2016-05-19	PART NAME: MICRO USB A/B 口 双向车削/ODP 0.6 (8.35*4.45) 无盖边
UNTR: mm [inch]	CHECKED BY : VIC	DATE : 2016-05-19	PART NO.: TMC81-(S)B005-835
SCALE: 1:1	APPROVED BY: DAVID	DATE : 2016-05-19	MOLD NO.:
SIZE: A4			DRAW NO.:
			SHEET NO.: